**Product data sheet** 

### 1. General description

The 74LVC00A is a quad 2-input NAND gate. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

### 2. Features and benefits

- · Overvoltage tolerant inputs to 5.5 V
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- · Direct interface with TTL levels
- Complies with JEDEC standard:
  - JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- · ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- · Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

# 3. Ordering information

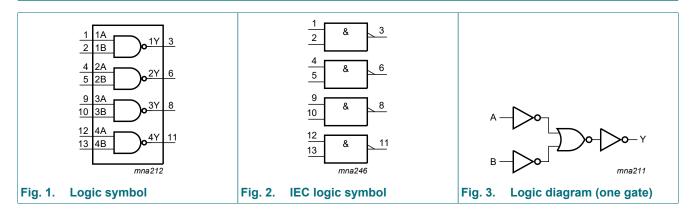
**Table 1. Ordering information** 

Type number	Package									
	Temperature range	Name	Description	Version						
74LVC00AD	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1						
74LVC00APW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1						
74LVC00ABQ	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	SOT762-1						



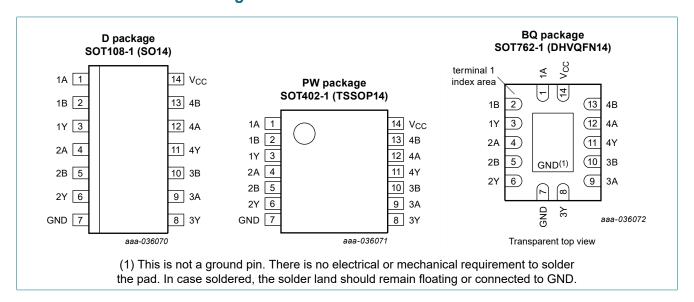
**Quad 2-input NAND gate** 

## 4. Functional diagram



# 5. Pinning information

### 5.1. Pinning



### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1A to 4A	1, 4, 9, 12	data input
1B to 4B	2, 5, 10, 13	data input
1Y to 4Y	3, 6, 8,11	data output
GND	7	ground (0 V)
V <sub>CC</sub>	14	supply voltage

**Quad 2-input NAND gate** 

## 6. Functional description

#### **Table 3. Function selection**

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care$ 

Input	Output	
nA	nB	nY
L	X	Н
X	L	Н
Н	Н	L

# 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$		-	±50	mA
Vo	output voltage	output in HIGH or LOW-state	[2]	-0.5	V <sub>CC</sub> + 0.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$		-	±50	mA
I <sub>CC</sub>	supply current			-	100	mA
I <sub>GND</sub>	ground current			-100	-	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[3]	-	500	mW
T <sub>stg</sub>	storage temperature			-65	+150	°C

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V <sub>I</sub>	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 1.65 V to 2.7 V	0	-	20	ns/V
		V <sub>CC</sub> = 2.7 V to 3.6 V	0	-	10	ns/V

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

<sup>[3]</sup> For SOT108-1 (SO14) package: P<sub>tot</sub> derates linearly with 10.1 mW/K above 100 °C. For SOT402-1 (TSSOP14) package: P<sub>tot</sub> derates linearly with 7.3 mW/K above 81 °C. For SOT762-1 (DHVQFN14) package: P<sub>tot</sub> derates linearly with 9.6 mW/K above 98 °C.

**Quad 2-input NAND gate** 

## 9. Static characteristics

**Table 6. Static characteristics** 

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	S °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	1
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	0.65V <sub>CC</sub>	-	-	0.65V <sub>CC</sub>	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.35V <sub>CC</sub>	-	0.35V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V <sub>OH</sub> HIGH-level		$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	V <sub>CC</sub> - 0.2	-	-	V <sub>CC</sub> - 0.3	-	V
		I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V	1.2	-	-	1.05	-	V
		$I_{O}$ = -8 mA; $V_{CC}$ = 2.3 V	1.8	-	-	1.65	-	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V	2.2	-	-	2.05	-	V
		I <sub>O</sub> = -18 mA; V <sub>CC</sub> = 3.0 V	2.4	-	-	2.25	-	V
		I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V	2.2	-	-	2.0	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>						
	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	-	0.45	-	0.65	V
		I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V	-	-	0.6	-	0.8	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	-	-	0.4	-	0.6	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	-	0.55	-	0.8	V
lį	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ
I <sub>CC</sub>	supply current	$V_{CC}$ = 3.6 V; $V_I$ = $V_{CC}$ or GND; $I_O$ = 0 A	-	0.1	10	-	40	μΑ
ΔI <sub>CC</sub>	additional supply current	per input pin; V <sub>CC</sub> = 2.7 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A	-	5	500	-	5000	μA
Cı	input capacitance	$V_{CC}$ = 0 V to 3.6 V; $V_{I}$ = GND to $V_{CC}$	-	4.0	-	-	-	pF

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V (unless stated otherwise) and  $T_{amb}$  = 25 °C.

**Quad 2-input NAND gate** 

# 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 5.

Symbol	Parameter	Conditions	-40	°C to +85	°C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	nA, nB to nY; see Fig. 4 [2	]					
		V <sub>CC</sub> = 1.2 V	-	12	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.3	3.8	8.4	0.3	9.7	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.2	4.8	1.0	5.7	ns
		V <sub>CC</sub> = 2.7 V	1.0	2.3	5.1	1.0	5.9	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.5	2.0	4.3	0.5	5.1	ns
t <sub>sk(o)</sub>	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ [3	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power dissipation	per gate; V <sub>I</sub> = GND to V <sub>CC</sub> [4	]					
capacitance		V <sub>CC</sub> = 1.65 V to 1.95 V	-	5.6	-	-	-	pF
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	8.9	-	-	-	pF
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	11.8	-	-	-	pF

- [1] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz

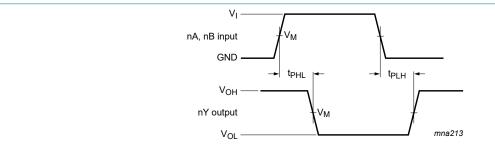
C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of the outputs}$ 

### 10.1. Waveforms and test circuit



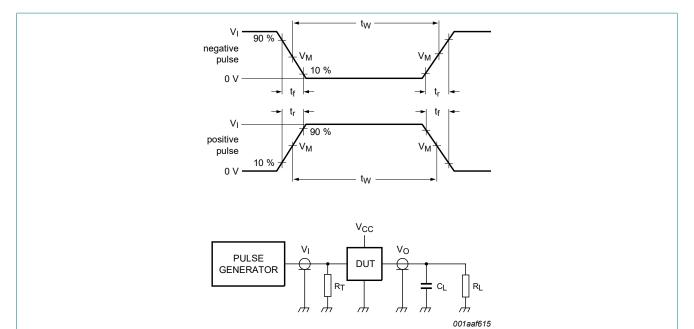
 $V_M = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V}.$ 

 $V_M = 0.5 \times V_{CC}$  at  $V_{CC} < 2.7 \text{ V}$ .

V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

Fig. 4. The input (nA, nB) to output (nY) propagation delays

### **Quad 2-input NAND gate**



Test data is given in <u>Table 8</u>. Definitions for test circuit:

R<sub>L</sub> = Load resistance

C<sub>L</sub> = Load capacitance including jig and probe capacitance

 $R_{T}$  = Termination resistance should be equal to output impedance  $Z_{\text{o}}$  of the pulse generator

Fig. 5. Test circuit for measuring switching times

Table 8. Test data

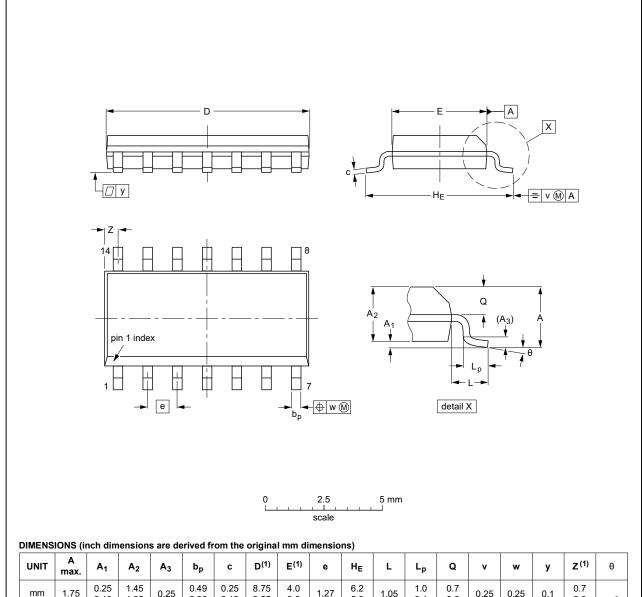
Supply voltage	Input	Input		
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	R <sub>L</sub>
1.2 V	V <sub>CC</sub>	≤ 2 ns	30 pF	1 kΩ
1.65 V to 1.95 V	V <sub>CC</sub>	≤ 2 ns	30 pF	1 kΩ
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2 ns	30 pF	500 Ω
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω

### **Quad 2-input NAND gate**

# 11. Package outline

### SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



ι	JNIT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
	mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
in	ches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

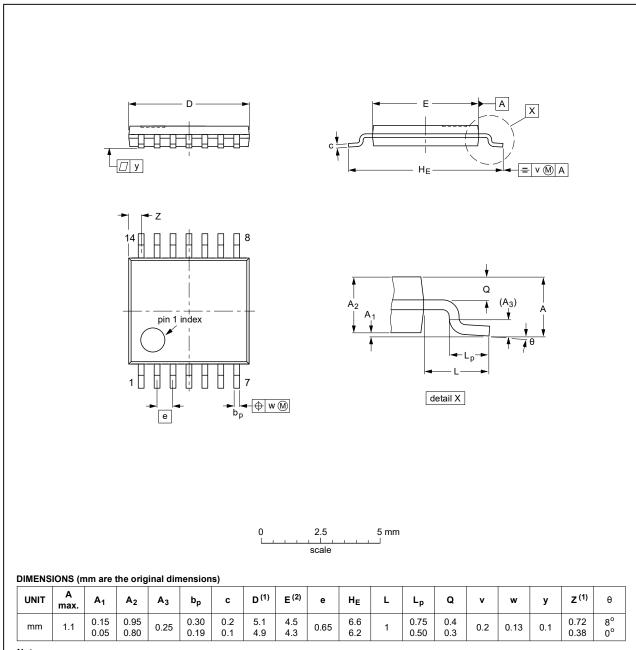
OUTLINE		REFER	EUROPEAN ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012				<del>99-12-27</del> 03-02-19

Fig. 6. Package outline SOT108-1 (SO14)

### **Quad 2-input NAND gate**

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN ISSUE DATE				
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT402-1		MO-153				<del>99-12-27</del> 03-02-18	

Fig. 7. Package outline SOT402-1 (TSSOP14)

**Product data sheet** 

**Quad 2-input NAND gate** 

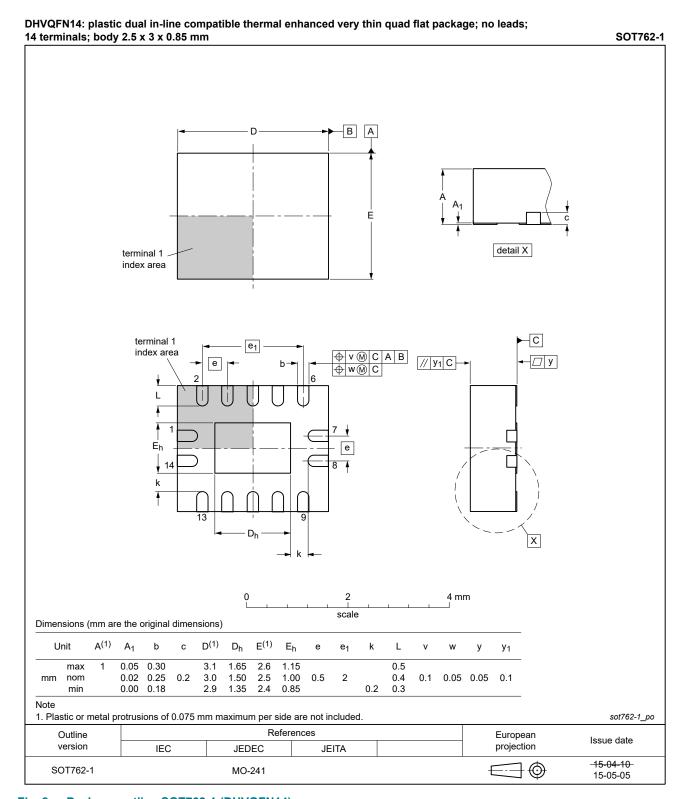


Fig. 8. Package outline SOT762-1 (DHVQFN14)

**Quad 2-input NAND gate** 

# 12. Abbreviations

#### **Table 9. Abbreviations**

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

# 13. Revision history

### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC00A v.10	20230801	Product data sheet	-	74LVC00A v.9		
Modifications:	Section 2:	<u>Section 2</u> : ESD specification updated according to the latest JEDEC standard.				
74LVC00A v.9	20210917	Product data sheet	-	74LVC00A v.8		
Modifications:		<ul> <li>Type number 74LVC00ADB (SOT337-1/SSOP14) removed.</li> <li>Section 1 updated.</li> </ul>				
74LVC00A v.8	20200824	Product data sheet	-	74LVC00A v.7		
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Table 4: Derating values for P<sub>tot</sub> total power dissipation have been updated.</li> <li>Package outline drawing of SOT762-1 (Fig. 8) updated.</li> </ul>					
74LVC00A v.7	20120425	Product data sheet	-	74LVC00A v.6		
Modifications:	• <u>Table 2</u> : Er	<u>Table 2</u> : Errata in pin description corrected.				
74LVC00A v.6	20120106	Product data sheet	-	74LVC00A v.5		
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Table 4, Table 5, Table 6, Table 7 and Table 8: values added for lower voltage ranges.</li> </ul>					
74LVC00A v.5	20030904	Product specification	-	74LVC00A v.4		
74LVC00A v.4	20030507	Product specification	-	74LVC00A v.3		
74LVC00A v.3	20020305	Product specification	-	74LVC00A v.2		
74LVC00A v.2	19980428	Product specification	-	74LVC00A v.1		
74LVC00A v.1	19970811	Product specification	-	-		

### **Quad 2-input NAND gate**

### 14. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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### **Quad 2-input NAND gate**

# **Contents**

1. General description	1
2. Features and benefits	1
3. Ordering information	1
4. Functional diagram	2
5. Pinning information	2
5.1. Pinning	2
5.2. Pin description	2
6. Functional description	3
7. Limiting values	3
8. Recommended operating conditions	3
9. Static characteristics	4
10. Dynamic characteristics	5
10.1. Waveforms and test circuit	5
11. Package outline	7
12. Abbreviations	10
13. Revision history	10
14. Legal information	11

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